

## 15N25

Power MOSFET

15A, 250V N-CHANNEL  
POWER MOSFET

## ■ DESCRIPTION

The UTC **15N25** is a N-channel enhancement MOSFET using UTC's advanced technology to provide the customers with perfect  $R_{DS(ON)}$ , high switching speed, high current capacity and low gate charge.

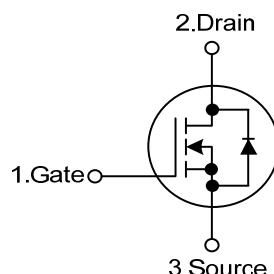
The UTC **15N25** is universally applied in low voltage such as automotive, high efficiency switching for AC/DC converters and DC motor control, etc.

## ■ FEATURES

\*  $R_{DS(ON)} \leq 0.32 \Omega$  @  $V_{GS}=10V$ ,  $I_D=7.5A$

\* High Switching Speed

## ■ SYMBOL



## ■ ORDERING INFORMATION

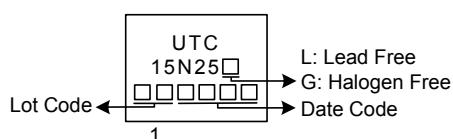
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
15N25L-TA3-T	15N25G-TA3-T	TO-220	G	D	S	Tube
15N25L-TF1-T	15N25G-TF1-T	TO-220F1	G	D	S	Tube
15N25L-TF3-T	15N25G-TF3-T	TO-220F	G	D	S	Tube
15N25L-TN3-R	15N25G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

15N25G-TA3-T  
 (1)Packing Type  
 (2)Package Type  
 (3)Green Package

(1) T: Tube, R: Tape Reel  
 (2) TA3: TO-220, TF1: TO-220F1, TF3: TO-220F  
 TN3: TO-252  
 (3) G: Halogen Free and Lead Free, L: Lead Free

## ■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	250	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Continuous Drain Current	Continuous	I <sub>D</sub>	15	A
	Pulsed	I <sub>DM</sub>	30	A
Single Pulsed Avalanche Current		I <sub>AS</sub>	15	A
Single Pulsed Avalanche Energy		E <sub>AS</sub>	186	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	6.4	V/ns
Power Dissipation	TO-220	P <sub>D</sub>	104	W
	TO-220F		40	W
	TO-220F1		56	W
	TO-252		+150	°C
Junction Temperature	T <sub>J</sub>		-55 ~ +150	°C
Storage Temperature	T <sub>STG</sub>			

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. L=1.58mH, I<sub>AS</sub>=15A, V<sub>DD</sub>=50V, R<sub>G</sub>=25 Ω, Starting T<sub>J</sub> = 25°C

4. I<sub>SD</sub>≤15A, di/dt≤200A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C

■ THERMAL DATA

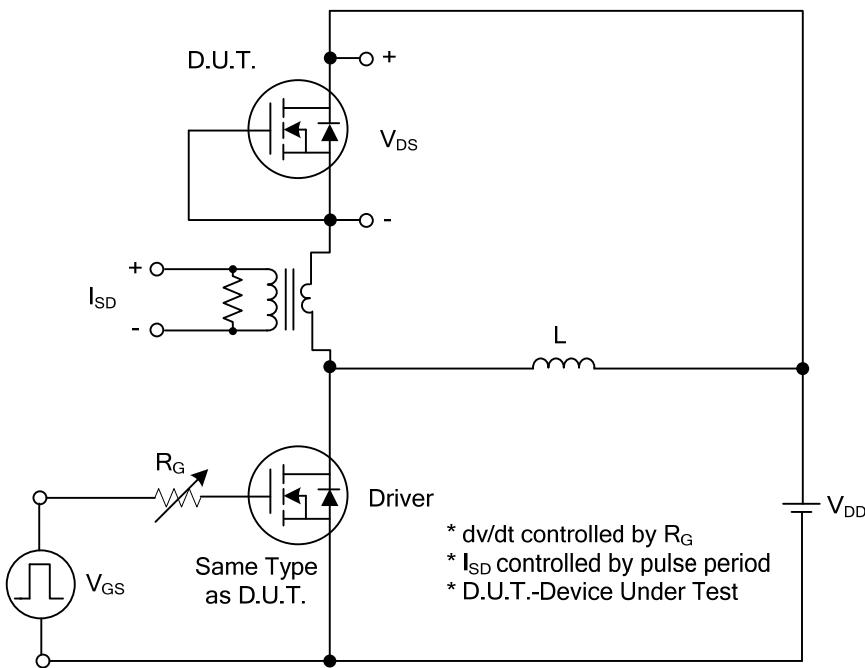
PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient	TO-220	θ <sub>JA</sub>	62.5	°C/W	
	TO-220F				
	TO-220F1		110		
Junction to Case	TO-252	θ <sub>JC</sub>	1.2	°C/W	
	TO-220		3.125		
	TO-220F				
	TO-220F1		2.23		
TO-252				°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

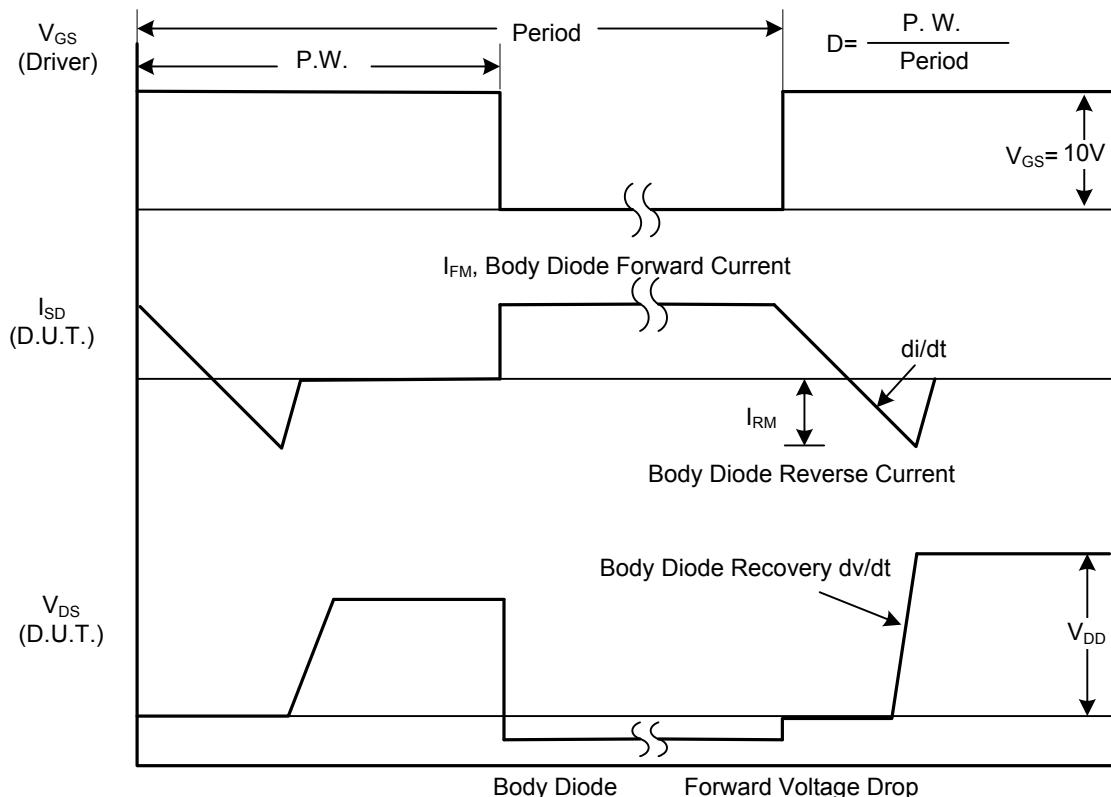
## ■ ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=250\mu A, V_{GS}=0V$	250			V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=250V, V_{GS}=0V$		10		$\mu A$
Gate-Source Leakage Current	Forward	$V_{GS}=+30V, V_{DS}=0V$		+100		nA
	Reverse	$V_{GS}=-30V, V_{DS}=0V$		-100		nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	4.0		V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=7.5A$		0.32		$\Omega$
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{ISS}$	$V_{GS}=0V, V_{DS}=25V, f=1.0MHz$		700		pF
Output Capacitance	$C_{OSS}$			125		pF
Reverse Transfer Capacitance	$C_{RSS}$			18		pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge	$Q_G$	$V_{DS}=200V, V_{GS}=10V, I_D=15A$ $I_G=1mA$ (Note 1, 2)		25		nC
Gate to Source Charge	$Q_{GS}$			8.6		nC
Gate to Drain Charge	$Q_{GD}$			7.6		nC
Turn-ON Delay Time	$t_{D(ON)}$	$V_{DD}=100V, I_D=15A, R_G=25\Omega$ (Note 1, 2)		10		ns
Rise Time	$t_R$			19		ns
Turn-OFF Delay Time	$t_{D(OFF)}$			55		ns
Fall-Time	$t_F$			22		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	$I_S$				15	A
Maximum Body-Diode Pulsed Current	$I_{SM}$				30	A
Drain-Source Diode Forward Voltage	$V_{SD}$	$I_S=15A, V_{GS}=0V$			1.5	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_S=15A, V_{GS}=0V, dI_F/dt=100A/\mu s$ (Note 1)		190		ns
Reverse Recovery Charge	$Q_{rr}$			2.8		$\mu C$

■ TEST CIRCUITS AND WAVEFORMS

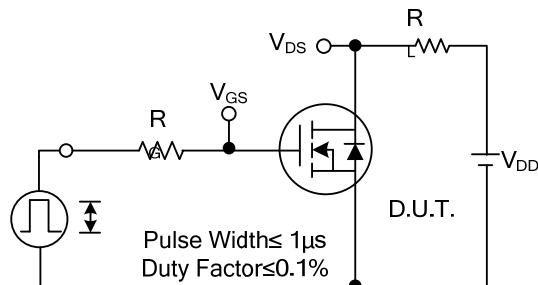


Peak Diode Recovery dv/dt Test Circuit

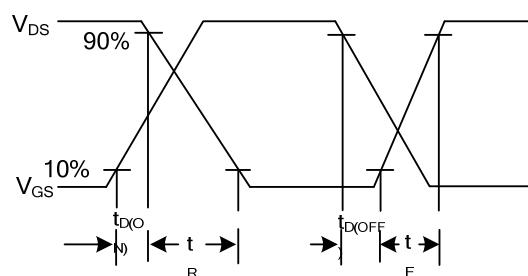


Peak Diode Recovery dv/dt Waveforms

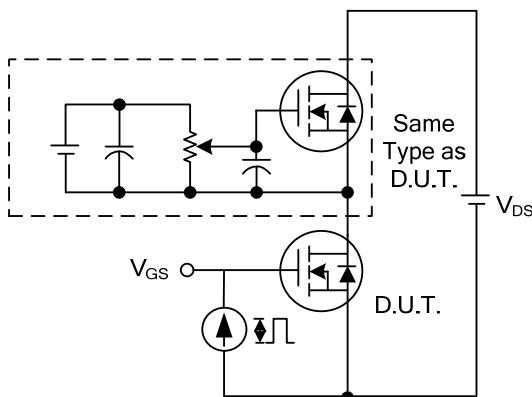
■ TEST CIRCUITS AND WAVEFORMS



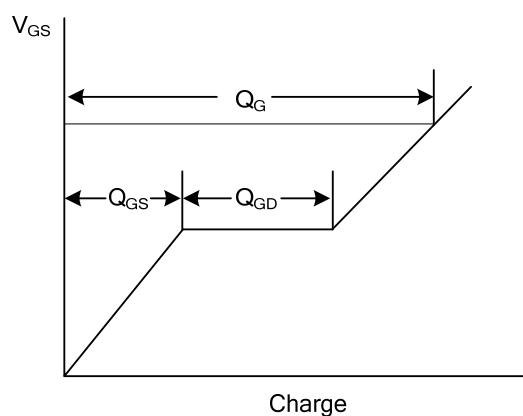
Switching Test Circuit



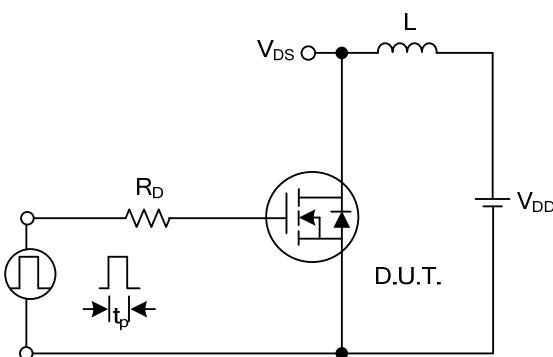
Switching Waveforms



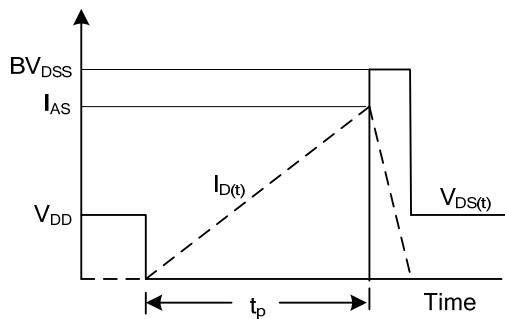
Gate Charge Test Circuit



Gate Charge Waveform

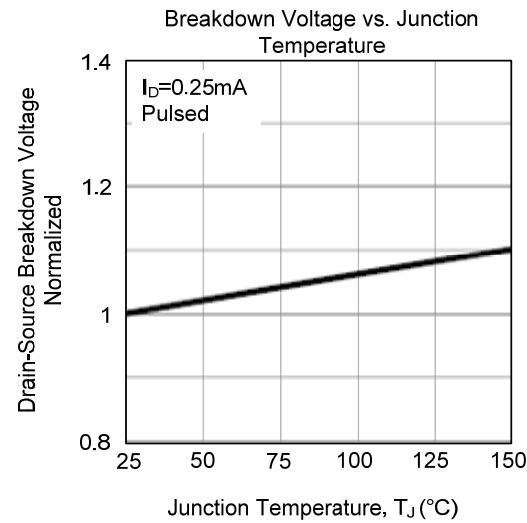
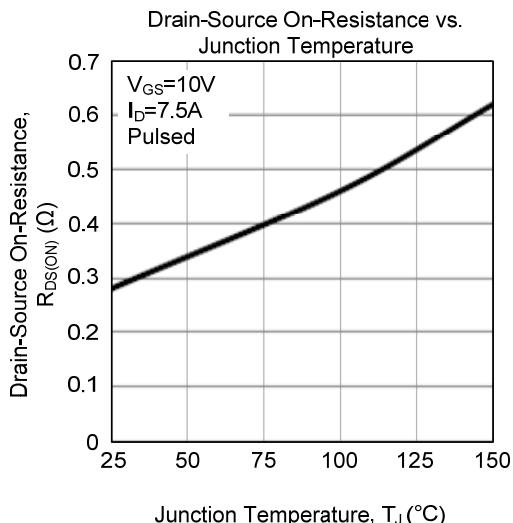
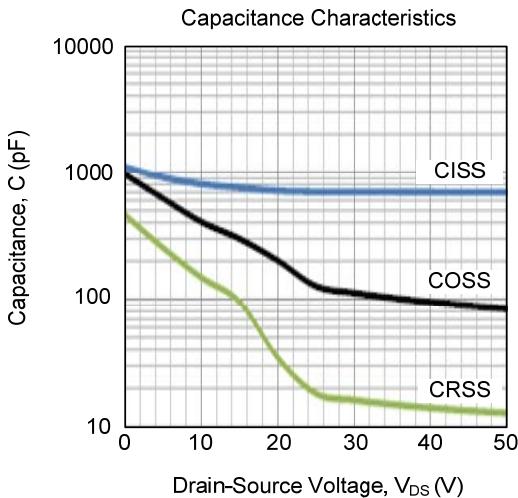
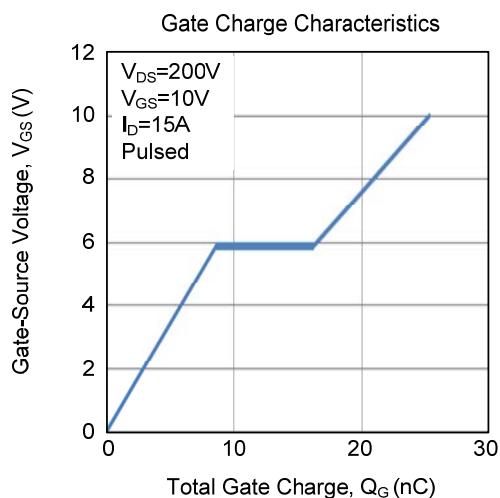
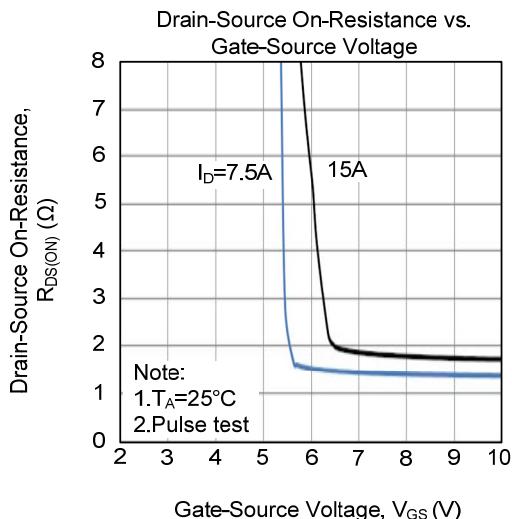
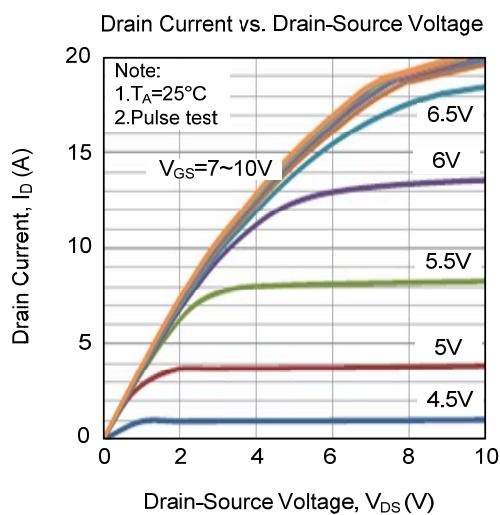


Unclamped Inductive Switching Test Circuit

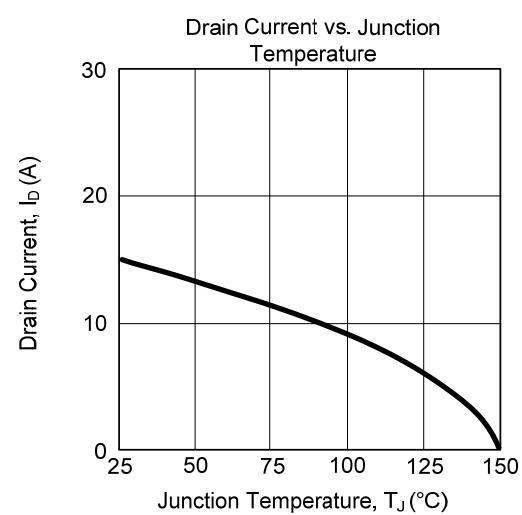
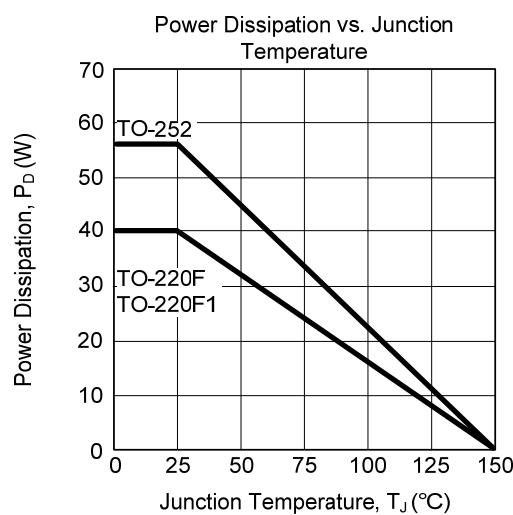
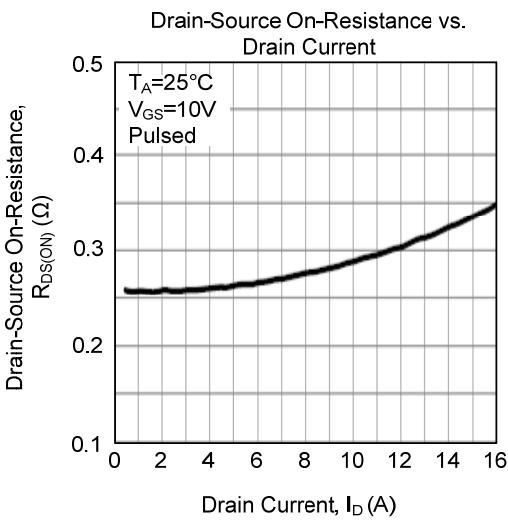
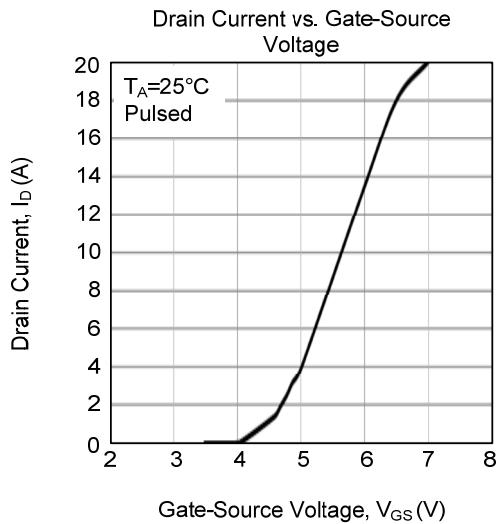
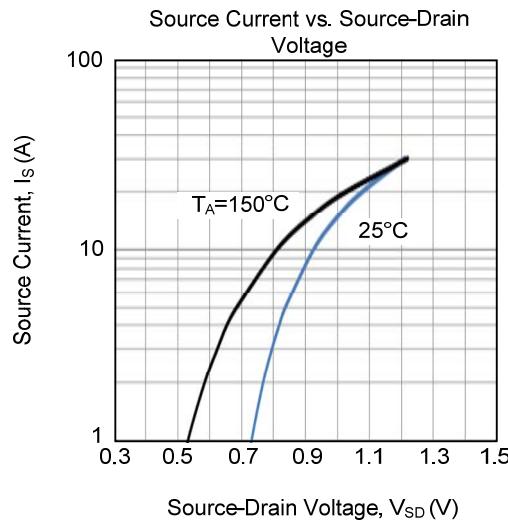
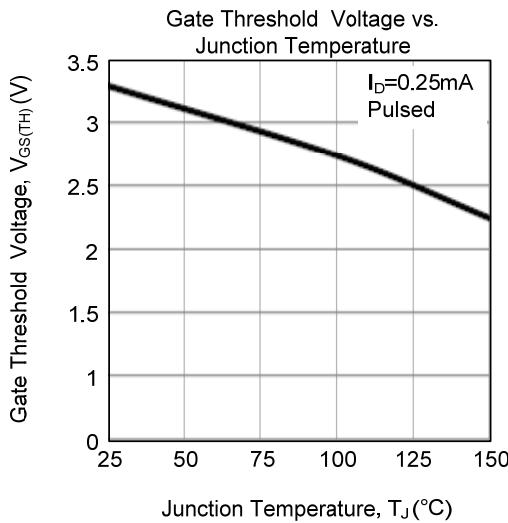


Unclamped Inductive Switching Waveforms

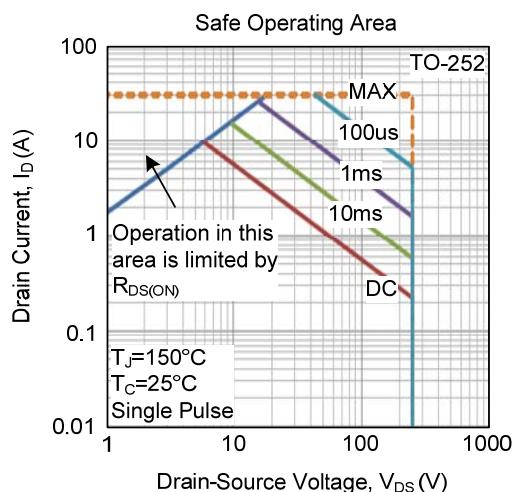
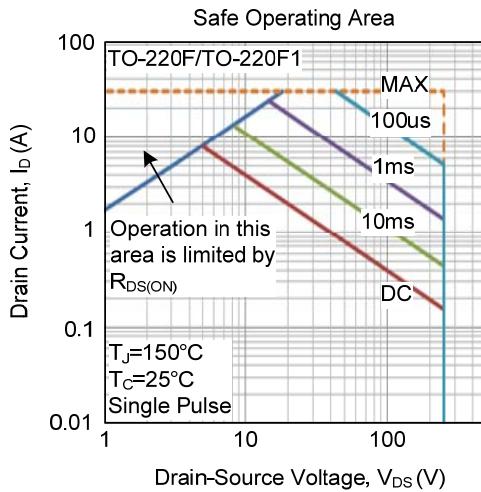
■ TYPICAL CHARACTERISTICS



## ■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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